Emitter common (dual digital transistors)

Datasheet

| Parameter | DTr1 and DTr2 |
|----------------------|---------------|
| V _{CC} | -50V |
| I _{C(MAX.)} | -100mA |
| R ₁ | 2.2kΩ |
| R ₂ | 47kΩ |

Features

- 1)Two DTA123J chips in a EMT or UMT or SMT package.
- 2) Mounting cost and area can be cut in half.

Outline

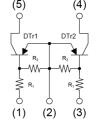
| SOT-553 | SOT-353 |
|----------------|-----------------|
| EMA5 (EMT5) | UMA5N (UMT5) |
| SOT-25 | |
| FMA5A | |

•Inner circuit

EMA5 / UMA5N

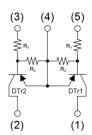
(SMT5)

- (1) DTr1 IN(Base)
- (2) DTr1 / DTr2 GND(Emitter)
- (3) DTr2 IN(Base)
- (4) DTr2 OUT(Collector)
- (5) DTr1 OUT(Collector)



FMA5A

- (1) DTr1 OUT(Collector)
- (2) DTr2 OUT(Collector)
- (3) DTr2 IN(Base)
- (4) DTr1 / DTr2 GND(Emitter)
- (5) DTr1 IN(Base)



Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

| | | | | ī | | | |
|----------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|------------|
| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
| EMA5 | SOT-553 (EMT5) | 1616 | T2R | 180 | 8 | 8000 | A5 |
| UMA5N | SOT-353 (UMT5) | 2021 | TR | 180 | 8 | 3000 | A5 |
| FMA5A | SOT-25 (SMT5) | 2928 | T148 | 180 | 8 | 3000 | A 5 |

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

| P | Parameter | Symbol | Values | Unit |
|---------------------------|------------------|---------------------|----------|------|
| Supply voltage | | | -50 | V |
| Input voltage | | | -12 to 5 | V |
| Output current | | | -100 | mA |
| Collector current | | | -100 | mA |
| | EMA5 | P _D *2*3 | 150 | |
| Power dissipation | UMA5N | P _D *2*3 | 150 | mW |
| | FMA5A | P _D *2*4 | 300 | |
| Junction temperature | T _j | 150 | °C | |
| Range of storage temperat | T _{stg} | -55 to +150 | °C | |

● Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Danamatan | C: reele el | Canditiana | Values | | | 1.1:4 | |
|----------------------|--------------------------------|---|--------|------|------|---------------------------------------|--|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit | |
| land the second | $V_{I(off)}$ | $V_{CC} = -5V, I_{O} = -100\mu A$ | - | - | -0.5 | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | |
| Input voltage | V _{I(on)} | $V_O = -0.3V$, $I_O = -5mA$ | -1.1 | - | - | V | |
| Output voltage | V _{O(on)} | I _O = -5mA, I _I = -0.25mA | - | -100 | -300 | mV | |
| Input current | I _I | V _I = -5V | - | - | -3.6 | mA | |
| Output current | I _{O(off)} | V _{CC} = -50V, V _I = 0V | - | - | -500 | nA | |
| DC current gain | G _I | V _O = -5V, I _O = -10mA | 80 | - | - | - | |
| Input resistance | R ₁ | - | 1.54 | 2.2 | 2.86 | kΩ | |
| Resistance ratio | R ₂ /R ₁ | - | 17 | 21 | 26 | - | |
| Transition frequency | f _T *1 | V _{CE} = -10V, I _E = 5mA, f = 100MHz | - | 250 | - | MHz | |

^{*1} Characteristics of built-in transistor.



^{*2} Each terminal mounted on a reference land.

^{*3 120}mW per element must not be exceeded.

^{*4 200}mW per element must not be exceeded.

● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

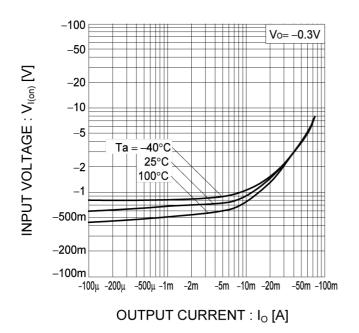


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

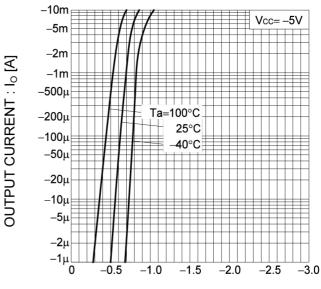


Fig.3 Output Current vs. Output Voltage

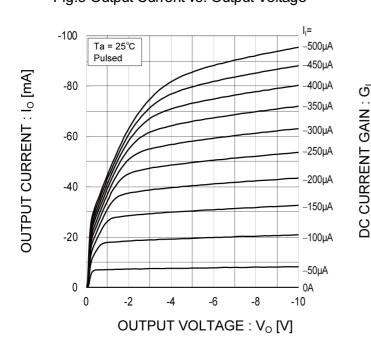
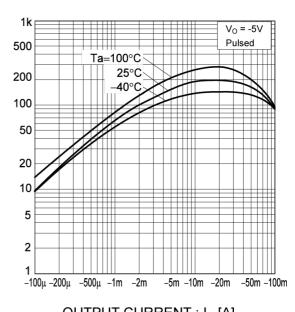


Fig.4 DC Current Gain vs. Output Current

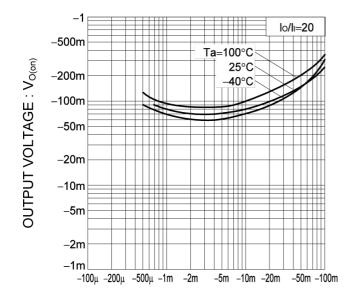
INPUT VOLTAGE: V_{I(off)} [V]



● Electrical characteristic curves (T_a = 25°C)

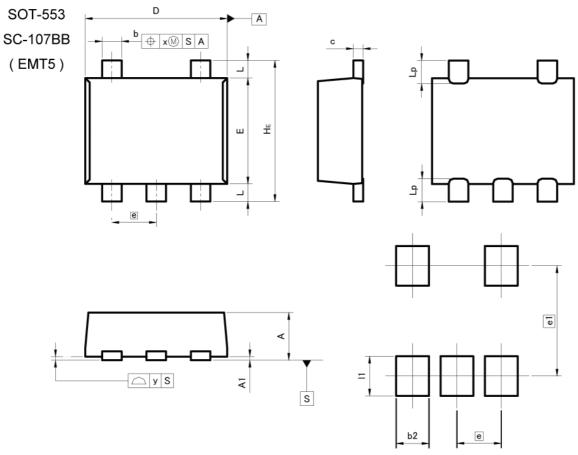
<For DTr1 and DTr2 in common>

Fig.5 Output Voltage vs. Output Current



OUTPUT CURRENT : I_O [A]

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

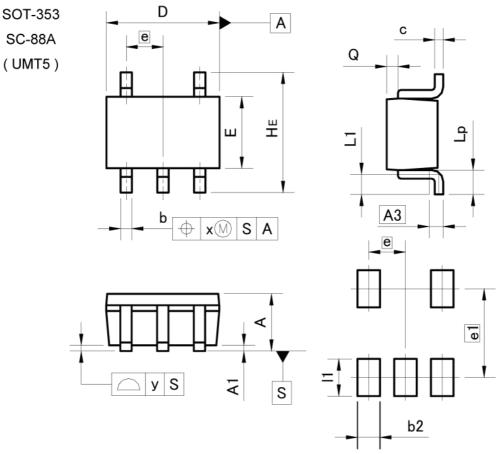
| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.45 | 0.55 | 0.018 | 0.022 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| b | 0.17 | 0.27 | 0.007 | 0.011 |
| С | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.50 | 1.70 | 0.059 | 0.067 |
| E | 1.10 | 1.30 | 0.043 | 0.051 |
| е | 0. | 50 | 0.0 | 20 |
| HE | 1.50 | 1.70 | 0.059 | 0.067 |
| L | 0.10 | 0.30 | 0.004 | 0.012 |
| Lp | _ | 0.35 | - | 0.014 |
| х | _ | 0.10 | _ | 0.004 |
| У | _ | 0.10 | _ | 0.004 |

| DIM | MILIMETERS | | MILIMETERS INCH | | HES |
|------|------------|------|-----------------|-------|-----|
| DIM | MIN | MAX | MIN | MAX | |
| b2 | - | 0.37 | _ | 0.015 | |
| e1 | 1.25 | | 0.0 | 49 | |
| - 11 | - | 0.45 | - | 0.018 | |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

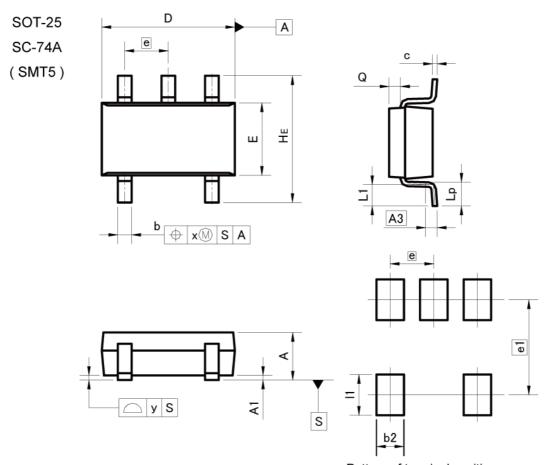
| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.80 | 1.00 | 0.031 | 0.039 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0.3 | 25 | 0.0 | 10 |
| b | 0.15 | 0.30 | 0.006 | 0.012 |
| С | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 1.90 | 2.10 | 0.075 | 0.083 |
| E | 1.15 | 1.35 | 0.045 | 0.053 |
| е | 0.0 | 65 | 0.0 | 26 |
| HE | 2.00 | 2.20 | 0.079 | 0.087 |
| L1 | 0.20 | 0.50 | 0.008 | 0.020 |
| Lp | 0.25 | 0.55 | 0.010 | 0.022 |
| Q | 0.10 | 0.30 | 0.004 | 0.012 |
| х | - | 0.10 | - | 0.004 |
| У | | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| DIM | MIN | MAX | MIN | MAX |
| b2 | - 7 | 0.40 | - | 0.016 |
| e1 | 1.55 | | 0.0 | 61 |
| 11 | - | 0.65 | - | 0.026 |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | ETERS | INC | HES |
|-----|-------|-------|--|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 1.00 | 1.30 | 0.039 | 0.051 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0.: | 25 | 0.0 | 110 |
| b | 0.25 | 0.40 | 0.010 | 0.016 |
| С | 0.09 | 0.25 | 0.004 | 0.010 |
| D | 2.80 | 3.00 | 0.110 | 0.118 |
| Е | 1.50 | 1.80 | 0.059 | 0.071 |
| е | 0.9 | 95 | 0.0 | 37 |
| HE | 2.60 | 3.00 | 0.102 | 0.118 |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 |
| Lp | 0.40 | 0.70 | 0.016 | 0.028 |
| Q | 0.20 | 0.30 | 0.008 | 0.012 |
| х | | 0.20 | = 2 | 0.008 |
| У | | 0.10 | - // ₁ / ₁ / ₁ | 0.004 |

| DIM | | MILIMETERS | | INCHES | |
|-----|-----|------------|------|------------|-------|
| DIM | MIN | MAX | MIN | MAX | |
| | b2 | - | 0.60 | - 0 | 0.024 |
| | e1 | 2.10 | | 0.0 | 83 |
| | 11 | - | 0.90 | - | 0.035 |

Dimension in mm/inches



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| JAPAN | USA | EU | CHINA |
|---------|----------|------------|-----------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CL ACCIII |
| CLASSIV | CLASSIII | CLASSⅢ | CLASSIII |

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